



**SUGGESTED PCB LAYOUT
(COMPONENT SIDE)**

1. MATERIAL:
 HOUSING: PBT, BLACK, UL94V-0
 CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH
 100 μ m MINIMUM THICK TIN IN SOLDER AREA.
 15 μ m MINIMUM GOLD IN LOCALIZED PLATE AREA.
 ENTIRE CONTACTS PLATED WITH 30 μ m MINIMUM THICK NICKEL.
2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
3. PART NUMBER: HRJ801215-U2588-F1

				JOINT TECH ELECTRONIC IND. CO., LTD. JOY DAY INDUSTRIAL CO., LTD.	
		UNIT	SCALE	SHEET	TITLE:
		mm[inch]		1 of 1	DOUBLE STACK MODULAR JACK, 2X5, W/O LED, 8P, 8C, UNSHIELDED, THRU-HOLE
		DRAWN BY	APPROVED BY		
		董正一 2004.10.06	董正一 2004.10.06		
		GENERAL TOLERANCE			
		X. X \pm 0.25	ANGLE \pm		DRAW NO. : HRJ801215-U2588-F1
BO	NEW RELEASE	2005.12.25	X. XX \pm 0.15		
REV.	DESCRIPTION	DATE	X. XXX \pm 0.05		